APPLICA	BLE STANI	DARD						
OPERATING TEMPERATUR		E RANGE	-35°C TO + 85°C(NOTE 1)	ТЕМІ	RAGE PERATURE RANGE	-10°C TO + 60°C (NOTE 2)		
RATING	VOLTAGE CURRENT		1 1500 40		LICABLE NECTOR	DF13/DF13A-40DP-1. 25V (55) DF13/DF13A-40DP-1. 25V (56)		
			SPECIFICA ⁻	TIOI	NS			
l-	ITEM		TEST METHOD	REQUIREMENTS			АТ	
CONSTR	RUCTION							
GENERAL EX	AMINATION	VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.			Х
MARKING		CONFIRMED VISUALLY.					X	Х
ELECTR	IC CHARA	CTERI	STICS					
CONTACT	RESISTANCE	100m A (DC OR 1000 Hz).			30mΩ MAX.			_
INSULATIO RESISTANO		100V DC.			500MΩ MIN.			_
VOLTAGE F	VOLTAGE PROOF		OV AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.			_
MECHAI	VICAL CHA	RACTI	ERISTICS					
MECHANIC	AL	50TIMES INSERTIONS AND EXTRACTIONS.			① CONTACT RES	SISTANCE: 30mΩ MAX.		
OPERATION					② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			-
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS			_
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			OF PARTS.		Х	_
ENVIRO	NMENTAL	CHAR	ACTERISTICS		L		•	
RAPID CHA	NGE OF	TEMPER	RATURE -55→ 5 TO 35→+85→ 5 TO	35 °C	① CONTACT RESI	STANCE: 30mΩ MAX.	X	
TEMPERATURE		TIME $30 \rightarrow 2 \text{ TO } 3 \rightarrow 30 \rightarrow 2 \text{ TO } 3 \text{ min}$ UNDER 5 CYCLES.			② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			-
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 500MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 		Х	_
CORROSIN,SALT MIST		EXPOSED IN 5% SALT WATER SPRAY FOR 48h.			NO HEAVY CORROSION.			_
SULPHUR DIOXIDE		EXPOSED IN 10 PPM FOR 96h. (TEST STANDARD: JEIDA-39)			NO HEAVY CORROSION.			_
RESISTANCE TO SOLDERING HEAT		SOLDER TEMPERATURE, 260 ± 5°C, FOR IMMERSION, DURATION, 5S.			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.			_
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 230 ± 10°C FOR INSERTION DURATION, 3 SECONDS.			SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.			_

NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.
NOTE2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD AFTER PCBBOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.

Unless otherwise specifid, refer to JIS C 5402.

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	COUN	T DESCRIPTION OF REVISIONS	DESIGNED		CHECKED	DATE
Δ						
				APPROVED	TY.OMA	06.02.02
			CHECKED	HK.UMEHARA	06.02.02	
				DESIGNED	TS.KUMAZAWA	06.01.31
				DRAWN	AK.MIURA	06.01.25
Not	Note QT:Qualification Test AT:Assurance Test X:Applicable Test			IG NO.	ELC4-160787-02	
1	RS	SPECIFICATION SHEET	PART NO.	DF13-40DS-1, 25DSA (5		(55)
		HIROSE ELECTRIC CO., LTD.	CODE NO.	CL53	6-0635-3-55	1/1